

## General Description

The MY70N10D use advanced SGT MOSFET technology to provide low RDS(ON), low gate charge, fast switching and excellent avalanche characteristics. This device is specially designed to get better ruggedness and suitable to use in

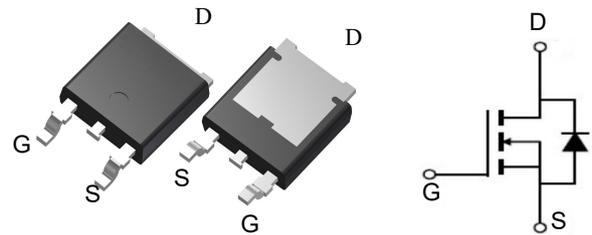


## Features

|   |     |    |
|---|-----|----|
| V <sub>DSS</sub>                                | 100 | V  |
| I <sub>D</sub>                                  | 68  | A  |
| R <sub>DS(ON)</sub> (at V <sub>GS</sub> = 10V)  | 7   | mΩ |
| R <sub>DS(ON)</sub> (at V <sub>GS</sub> = 4.5V) | 8.3 | mΩ |

## Application

- Battery protection
- Load switch
- Uninterruptible power supply



## Package Marking and Ordering Information

| Product ID | Pack      | Marking  | Qty(PCS) |
|------------|-----------|----------|----------|
| MY70N10D   | TO-252-2L | MY70N10D | 2500     |

## Absolute Maximum Ratings (T<sub>c</sub>=25 °C unless otherwise noted)

| Parameter  | Symbol                            | Value      | Unit |
|--|-----------------------------------|------------|------|
| Drain source voltage   | V <sub>DS</sub>                   | 100        | V    |
| Gate source voltage  | V <sub>GS</sub>                   | ±20        | V    |
| Continuous drain current <sup>1)</sup> , T <sub>c</sub> =25 °C | I <sub>D</sub>                    | 68         | A    |
| Pulsed drain current <sup>2)</sup> , T <sub>c</sub> =25 °C     | I <sub>D</sub> , pulse            | 180        | A    |
| Power dissipation <sup>3)</sup> , T <sub>c</sub> =25 °C        | P <sub>D</sub>                    | 125        | W    |
| Single pulsed avalanche energy <sup>5)</sup>                   | E <sub>AS</sub>                   | 100        | mJ   |
| Operation and storage temperature                              | T <sub>stg</sub> , T <sub>j</sub> | -55 to 150 | °C   |
| Thermal resistance, junction-case                              | R <sub>θJC</sub>                  | 1          | °C/W |
| Thermal resistance, junction-ambient <sup>4)</sup>             | R <sub>θJA</sub>                  | 62         | °C/W |

**Electrical Characteristics ( $T_J=25\text{ }^\circ\text{C}$ , unless otherwise noted)**

| Parameter                        | Symbol        | Min. | Typ.  | Max. | Unit             | Test condition  |
|----------------------------------|---------------|------|-------|------|------------------|---|
| Drain-source breakdown voltage   | BVDSS         | 100  |       |      | V                | $V_{GS}=0\text{ V}$ , $I_D=250\text{ }\mu\text{A}$  |
| Gate threshold voltage           | $V_{GS(th)}$  | 1.2  | 2.0   | 2.5  | V                | $V_{DS}=V_{GS}$ , $I_D=250\text{ }\mu\text{A}$  |
| Drain-source on-state resistance | $R_{DS(ON)}$  |      | 7.0   | 8.0  | $\text{m}\Omega$ | $V_{GS}=10\text{ V}$ , $I_D=20\text{ A}$  |
| Drain-source on-state resistance | $R_{DS(ON)}$  |      | 8.3   | 10.8 | $\text{m}\Omega$ | $V_{GS}=4.5\text{ V}$ , $I_D=15\text{ A}$   |
| Gate-source leakage current      | IGSS          |      |       | 100  | nA               | $V_{GS}=20\text{ V}$  |
|                                  |               |      |       | -100 |                  | $V_{GS}=-20\text{ V}$   |
| Drain-source leakage current     | IDSS          |      |       | 1    | $\mu\text{A}$    | $V_{DS}=80\text{ V}$ , $V_{GS}=0\text{ V}$  |
| Input capacitance                | $C_{iss}$     |      | 2000  |      | pF               | $V_{GS}=0\text{ V}$ , $V_{DS}=50\text{ V}$ , $f=1\text{ MHz}$                                   |
| Output capacitance               | $C_{oss}$     |      | 943.1 |      | pF               |   |
| Reverse transfer capacitance     | $C_{rss}$     |      | 57.6  |      | pF               |   |
| Turn-on delay time               | $t_{d(on)}$   |      | 20.6  |      | ns               | $V_{GS}=10\text{ V}$ , $V_{DS}=50\text{ V}$ ,<br>$R_G=2.2\text{ }\Omega$ ,<br>$I_D=25\text{ A}$ |
| Rise time                        | $t_r$         |      | 5     |      | ns               |   |
| Turn-off delay time              | $t_{d(off)}$  |      | 51.8  |      | ns               |   |
| Fall time                        | $t_f$         |      | 9     |      | ns               |   |
| Total gate charge                | $Q_g$         |      | 49.9  |      | nC               | $I_D=25\text{ A}$ ,<br>$V_{DS}=50\text{ V}$ ,<br>$V_{GS}=10\text{ V}$                           |
| Gate-source charge               | $Q_{gs}$      |      | 6.5   |      | nC               |   |
| Gate-drain charge                | $Q_{gd}$      |      | 12.4  |      | nC               |   |
| Gate plateau voltage             | $V_{plateau}$ |      | 3.4   |      | V                |   |
| Diode forward current            | $I_S$         |      |       | 60   |                  | $V_{GS}<V_{th}$   |
| Pulsed source current            | ISP           |      |       | 180  | A                |   |
| Diode forward voltage            | VSD           |      |       | 1.3  | V                | $I_S=12\text{ A}$ , $V_{GS}=0\text{ V}$   |
| Reverse recovery time            | $t_{rr}$      |      | 60.4  |      | ns               | $I_S=12\text{ A}$ , $di/dt=100\text{ A}/\mu\text{s}$  |
| Reverse recovery charge          | $Q_{rr}$      |      | 106.1 |      | nC               |   |
| Peak reverse recovery current    | $I_{rrm}$     |      | 3     |      | A                |   |

**Note**

- 1) Calculated continuous current based on maximum allowable junction temperature.
- 2) Repetitive rating; pulse width limited by max. junction temperature.
- 3)  $P_d$  is based on max. junction temperature, using junction-case thermal resistance.
- 4) The value of  $R_{\theta JA}$  is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with  $T_a=25\text{ }^\circ\text{C}$ .
- 5)  $V_{DD}=50\text{ V}$ ,  $R_G=25\text{ }\Omega$ ,  $L=0.3\text{ mH}$ , starting  $T_J=25\text{ }^\circ\text{C}$ .

**Typical Characteristics**

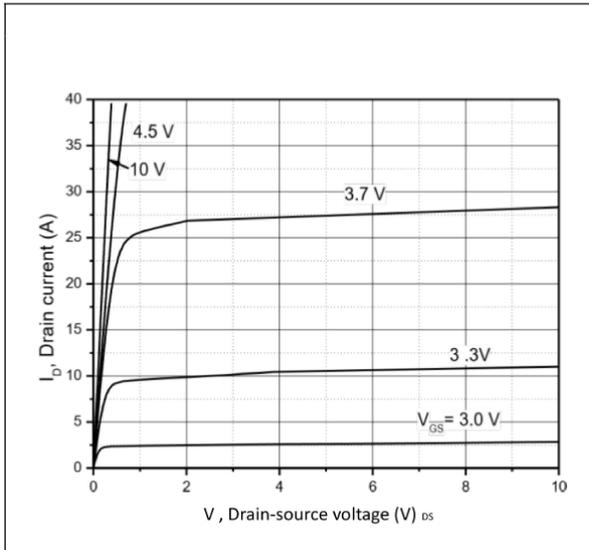


Figure 1, Typ. output characteristics

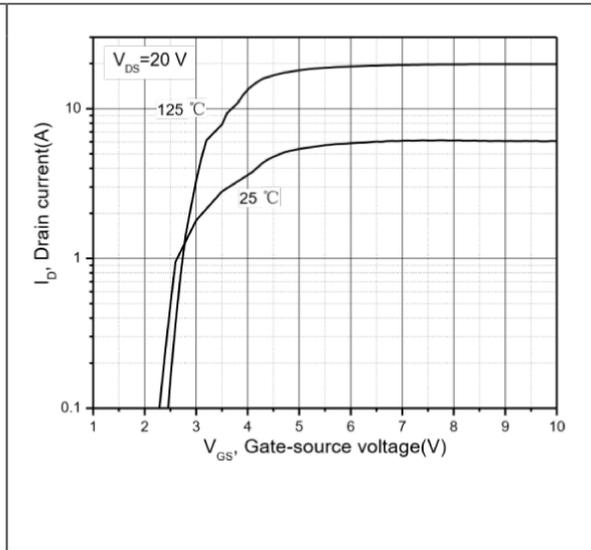


Figure 2, Typ. transfer characteristics

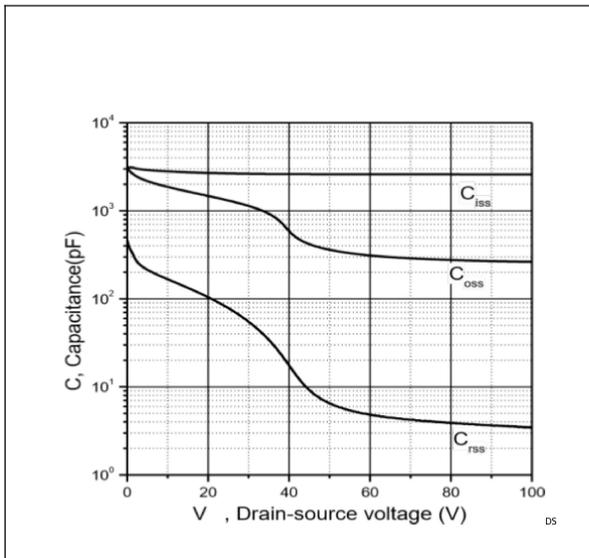


Figure 3, Typ. capacitances

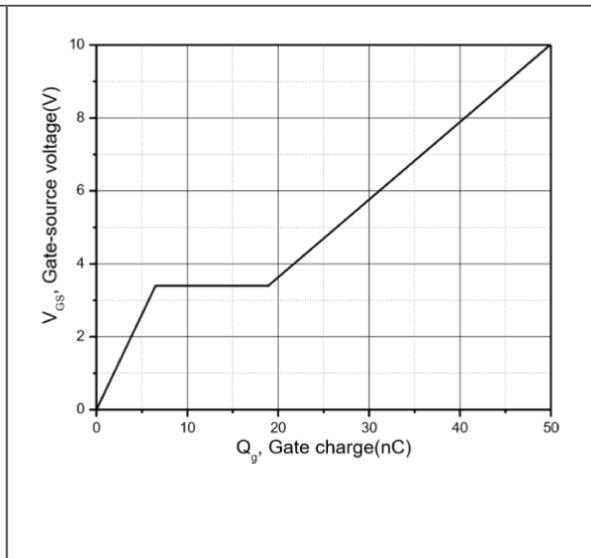


Figure 4, Typ. gate charge

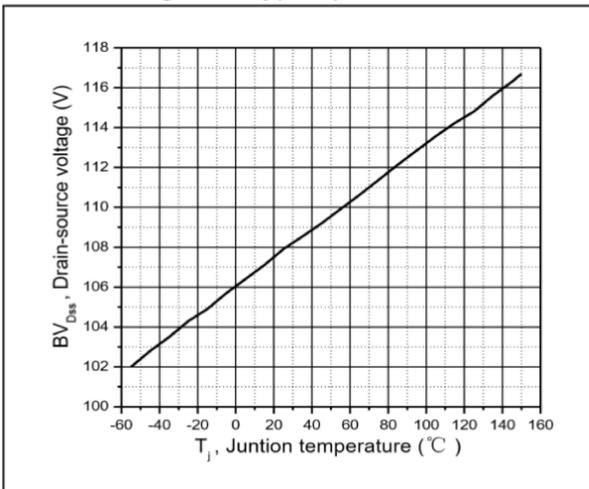


Figure 5, Drain-source breakdown voltage

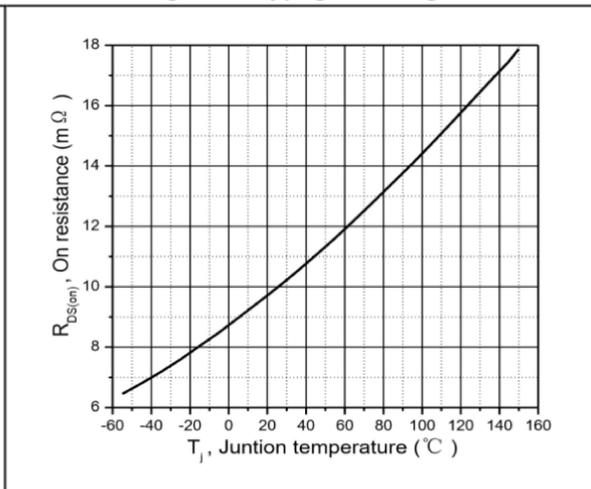


Figure 6, Drain-source on-state resistance

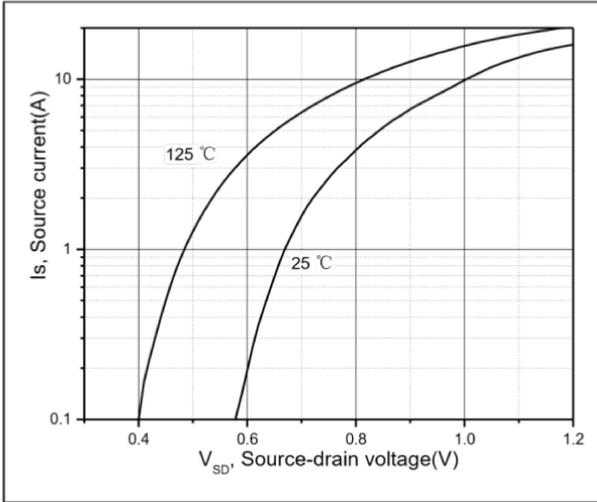


Figure 7, Forward characteristic of body diode

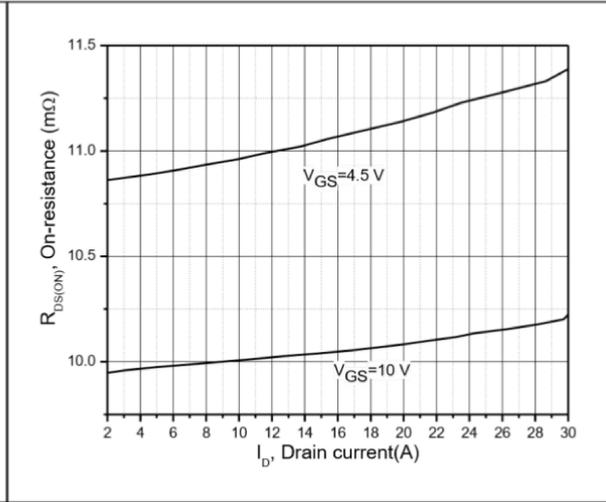


Figure 8, Drain-source on-state resistance

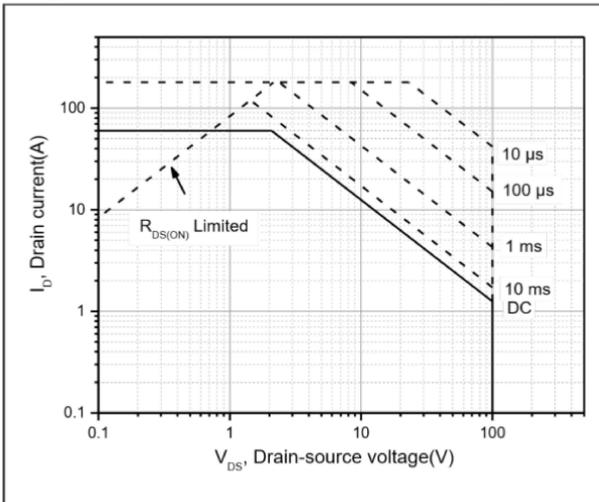


Figure 9, Safe operation area  $T_C=25\text{ }^{\circ}\text{C}$

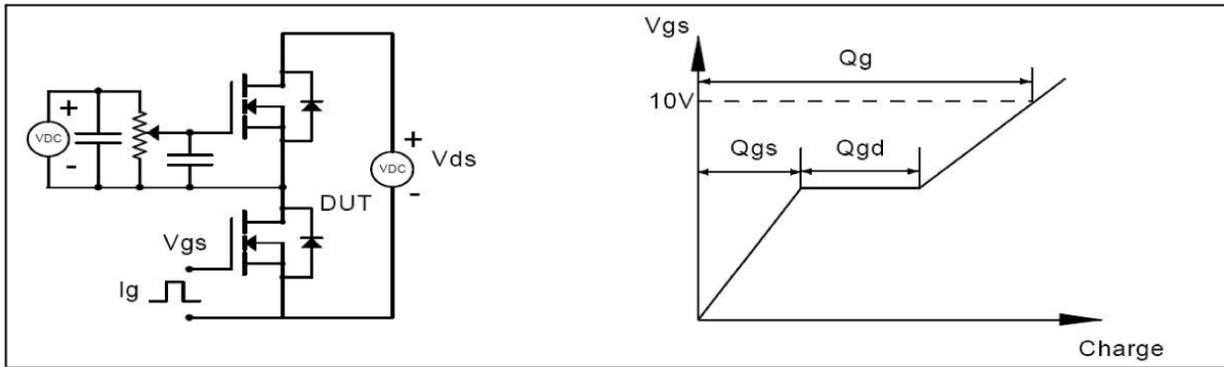


Figure 1, Gate charge test circuit & waveform

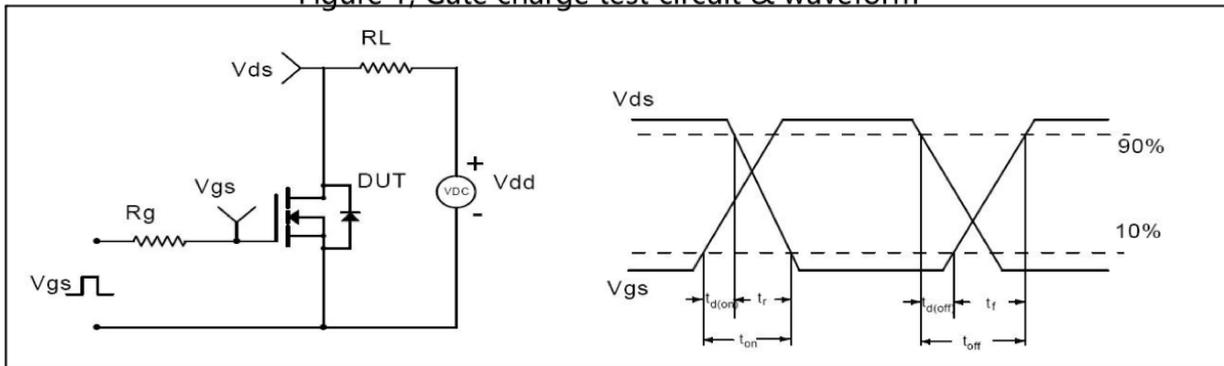


Figure 2, Switching time test circuit & waveforms

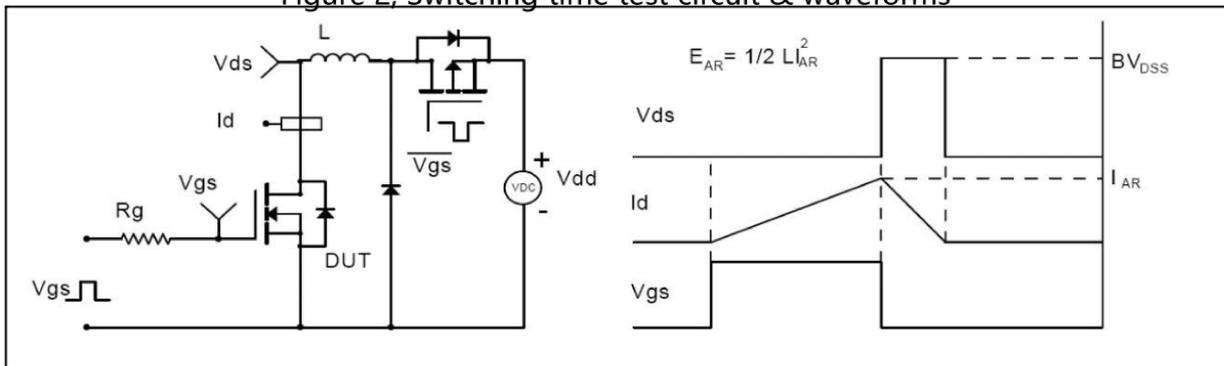


Figure 3, Unclamped inductive switching (UIS) test circuit & waveforms

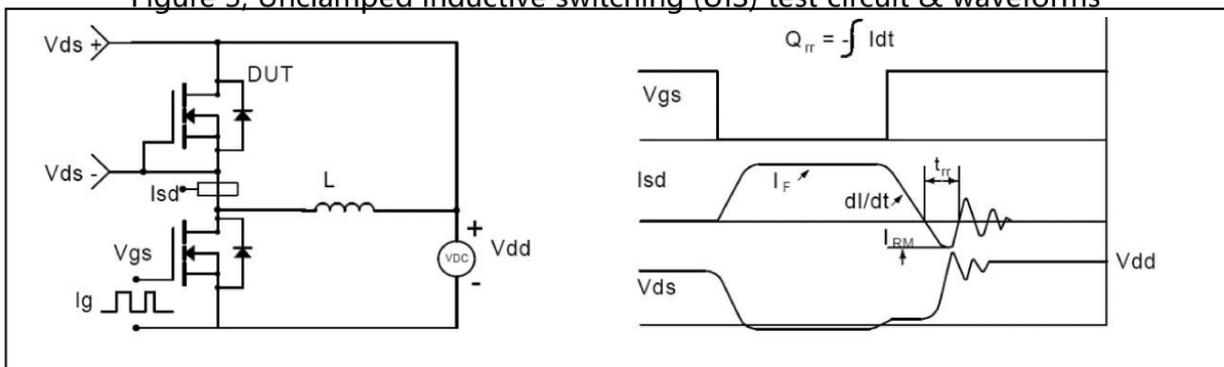
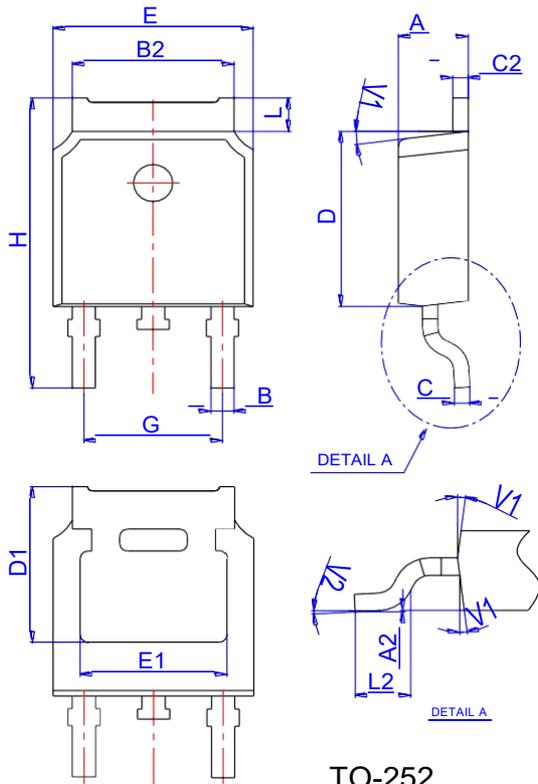


Figure 4, Diode reverse recovery test circuit & waveforms

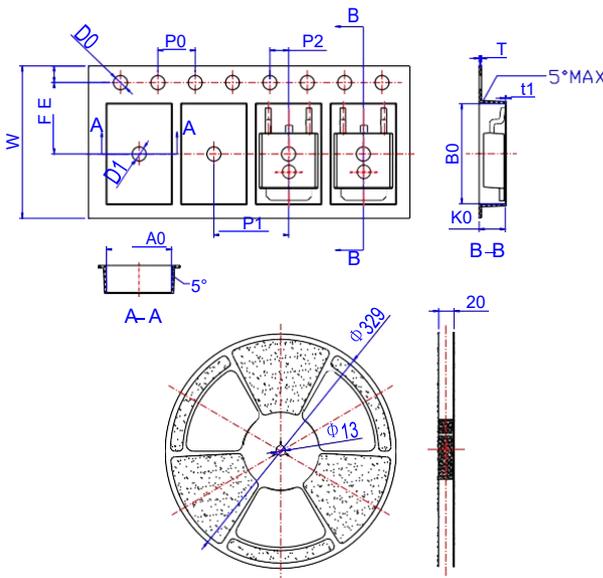
**Package Mechanical Data-TO-252-JQ Single**



| Ref. | Dimensions  |      |       |          |      |       |
|------|-------------|------|-------|----------|------|-------|
|      | Millimeters |      |       | Inches   |      |       |
|      | Min.        | Typ. | Max.  | Min.     | Typ. | Max.  |
| A    | 2.10        |      | 2.50  | 0.083    |      | 0.098 |
| A2   | 0           |      | 0.10  | 0        |      | 0.004 |
| B    | 0.66        |      | 0.86  | 0.026    |      | 0.034 |
| B2   | 5.18        |      | 5.48  | 0.202    |      | 0.216 |
| C    | 0.40        |      | 0.60  | 0.016    |      | 0.024 |
| C2   | 0.44        |      | 0.58  | 0.017    |      | 0.023 |
| D    | 5.90        |      | 6.30  | 0.232    |      | 0.248 |
| D1   | 5.30REF     |      |       | 0.209REF |      |       |
| E    | 6.40        |      | 6.80  | 0.252    |      | 0.268 |
| E1   | 4.63        |      |       | 0.182    |      |       |
| G    | 4.47        |      | 4.67  | 0.176    |      | 0.184 |
| H    | 9.50        |      | 10.70 | 0.374    |      | 0.421 |
| L    | 1.09        |      | 1.21  | 0.043    |      | 0.048 |
| L2   | 1.35        |      | 1.65  | 0.053    |      | 0.065 |
| V1   |             | 7°   |       |          | 7°   |       |
| V2   |             | 0°   | 6°    |          | 0°   | 6°    |

TO-252

**Reel Specification-TO-252**



| Ref. | Dimensions  |       |       |        |       |       |
|------|-------------|-------|-------|--------|-------|-------|
|      | Millimeters |       |       | Inches |       |       |
|      | Min.        | Typ.  | Max.  | Min.   | Typ.  | Max.  |
| W    | 15.90       | 16.00 | 16.10 | 0.626  | 0.630 | 0.634 |
| E    | 1.65        | 1.75  | 1.85  | 0.065  | 0.069 | 0.073 |
| F    | 7.40        | 7.50  | 7.60  | 0.291  | 0.295 | 0.299 |
| D0   | 1.40        | 1.50  | 1.60  | 0.055  | 0.059 | 0.063 |
| D1   | 1.40        | 1.50  | 1.60  | 0.055  | 0.059 | 0.063 |
| P0   | 3.90        | 4.00  | 4.10  | 0.154  | 0.157 | 0.161 |
| P1   | 7.90        | 8.00  | 8.10  | 0.311  | 0.315 | 0.319 |
| P2   | 1.90        | 2.00  | 2.10  | 0.075  | 0.079 | 0.083 |
| A0   | 6.85        | 6.90  | 7.00  | 0.270  | 0.271 | 0.276 |
| B0   | 10.45       | 10.50 | 10.60 | 0.411  | 0.413 | 0.417 |
| K0   | 2.68        | 2.78  | 2.88  | 0.105  | 0.109 | 0.113 |
| T    | 0.24        |       | 0.27  | 0.009  |       | 0.011 |
| t1   | 0.10        |       |       | 0.004  |       |       |
| 10P0 | 39.80       | 40.00 | 40.20 | 1.567  | 1.575 | 1.583 |